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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.25V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f530a-it

Table 2.9. Flash Electrical Characteristics

V_{DD} = 1.8 to 2.75 V; –40 to +125 ºC unless otherwise specified

Parameter	Conditions	Min	Typ	Max	Units
Flash Size	’F520/0A/1/1A and ’F530/0A/1/1A ’F523/3A/4/4A and ’F533/3A/4/4A ’F526/6A/7/7A and ’F536/6A/7/7A	7680 4096 2048	—	—	bytes
Endurance[2]	$V_{DD} \geq V_{RST\text{-}HIGH}$[1]	20 k	150 k	—	Erase/Write
Erase Cycle Time		27	32	38	ms
Write Cycle Time		57	65	74	µs
V_{DD}	Write/Erase Operations	$V_{RST\text{-}HIGH}$[1]	—	—	V

Notes:

1. See Table 2.8 on page 32 for the $V_{RST\text{-}HIGH}$ specification.
2. For –I (industrial Grade) parts, flash should be programmed (erase/write) at a minimum temperature of 0 °C for reliable flash operation across the entire temperature range of –40 to +125 °C. This minimum programming temperature does not apply to –A (Automotive Grade) parts.

Table 2.10. Port I/O DC Electrical Characteristics

V_{REGIN} = 2.7 to 5.25 V, –40 to +125 °C unless otherwise specified

Parameters	Conditions	Min	Typ	Max	Units
Output High Voltage	I_{OH} = –3 mA, Port I/O push-pull I_{OH} = –10 µA, Port I/O push-pull I_{OH} = –10 mA, Port I/O push-pull	V_{REGIN} – 0.4 V_{REGIN} – 0.02 —	— — V_{REGIN} – 0.7	— — —	V
Output Low Voltage	**V_{REGIN} = 2.7 V:** I_{OL} = 70 µA I_{OL} = 8.5 mA **V_{REGIN} = 5.25 V:** I_{OL} = 70 µA I_{OL} = 8.5 mA	 — — — —	 — — — —	 45 550 40 400	mV
Input High Voltage		V_{REGIN} x 0.7	—	—	V
Input Low Voltage		—	—	V_{REGIN} x 0.3	V
Input Leakage Current	Weak Pullup Off **C8051F52xA/53xA:** Weak Pullup On, V_{IN} = 0 V; V_{REGIN} = 1.8 V **C8051F52x/52xA/53x/53xA:** Weak Pullup On, V_{IN} = 0 V; V_{REGIN} = 2.7 V Weak Pullup On, V_{IN} = 0 V; V_{REGIN} = 5.25 V	— — — —	— 5 20 65	±2 15 50 115	µA

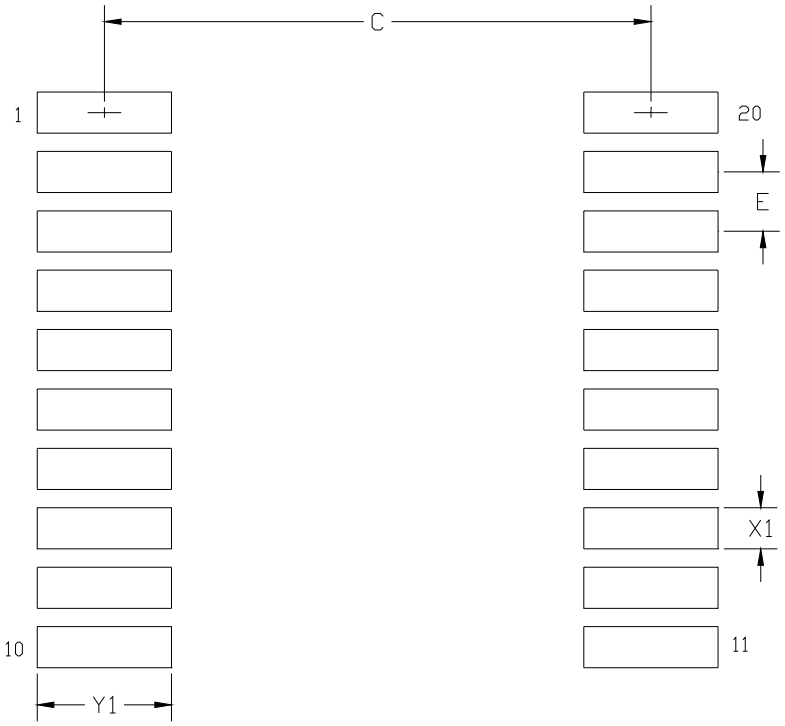


Figure 3.6. TSSOP-20 Landing Diagram

Table 3.6. TSSOP-20 Landing Diagram Dimensions

Symbol	Min	Max
C	5.80	5.90
E	0.65 BSC.	
X1	0.35	0.45
Y1	1.35	1.45

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This land pattern design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.

Card Assembly

7. A No-Clean, Type-3 solder paste is recommended.
8. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

4.3.6. Settling Time Requirements

A minimum tracking time is required before an accurate conversion can be performed. This tracking time is determined by the AMUX0 resistance, the ADC0 sampling capacitance, any external source resistance, and the accuracy required for the conversion.

Figure 4.6 shows the equivalent ADC0 input circuit. The required ADC0 settling time for a given settling accuracy (SA) may be approximated by Equation 4.1. When measuring the Temperature Sensor output, use the settling time specified in Table 2.3 on page 28. See Table 2.3 on page 28 for ADC0 minimum settling time requirements.

$$t = \ln\left(\frac{2^n}{SA}\right) \times R_{TOTAL} C_{SAMPLE}$$

Equation 4.1. ADC0 Settling Time Requirements

Where:
SA is the settling accuracy, given as a fraction of an LSB (for example, 0.25 to settle within 1/4 LSB)
t is the required settling time in seconds
R_{TOTAL} is the sum of the AMUX0 resistance and any external source resistance.
n is the ADC resolution in bits (12).

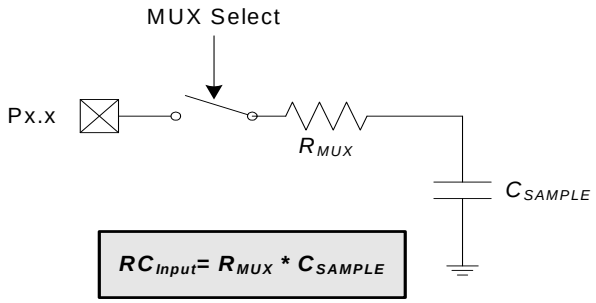


Figure 4.6. ADC0 Equivalent Input Circuits

4.4. Selectable Gain

ADC0 on the C8051F52x/52xA/53x/53xA family of devices implements a selectable gain adjustment option. By writing a value to the gain adjust address range, the user can select gain values between 0 and 1.016.

For example, three analog sources to be measured have full-scale outputs of 5.0 V, 4.0 V, and 3.0 V, respectively. Each ADC measurement would ideally use the full dynamic range of the ADC with an internal voltage reference of 1.5 V or 2.2 V (set to 2.2 V for this example). When selecting signal one (5.0 V full-scale), a gain value of 0.44 (5 V full scale * 0.44 = 2.2 V full scale) provides a full-scale signal of 2.2 V when the input signal is 5.0 V. Likewise, a gain value of 0.55 (4 V full scale * 0.55 = 2.2 V full scale) for the second source and 0.73 (3 V full scale * 0.73 = 2.2 V full scale) for the third source provide full-scale ADC0 measurements when the input signal is full-scale.

Additionally, some sensors or other input sources have small part-to-part variations that must be accounted for to achieve accurate results. In this case, the programmable gain value could be used as a calibration value to eliminate these part-to-part variations.

Note that false rising edges and falling edges can be detected when the comparator is first powered-on or if changes are made to the hysteresis or response time control bits. Therefore, it is recommended that the rising-edge and falling-edge flags be explicitly cleared to logic 0 a short time after the comparator is enabled or its mode bits have been changed. This Power Up Time is specified in Table 2.7 on page 31.

SFR Definition 7.1. CPT0CN: Comparator0 Control

R/W	R	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CP0EN	CP0OUT	CP0RIF	CP0FIF	CP0HYP1	CP0HYP0	CP0HYN1	CP0HYN0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9B

Bit7: **CP0EN**: Comparator0 Enable Bit.
0: Comparator0 Disabled.
1: Comparator0 Enabled.

Bit6: **CP0OUT**: Comparator0 Output State Flag.
0: Voltage on CP0+ < CP0–.
1: Voltage on CP0+ > CP0–.

Bit5: **CP0RIF**: Comparator0 Rising-Edge Flag.
0: No Comparator0 Rising Edge has occurred since this flag was last cleared.
1: Comparator0 Rising Edge has occurred.

Bit4: **CP0FIF**: Comparator0 Falling-Edge Flag.
0: No Comparator0 Falling-Edge has occurred since this flag was last cleared.
1: Comparator0 Falling-Edge has occurred.

Bits3–2: **CP0HYP1–0**: Comparator0 Positive Hysteresis Control Bits.
00: Positive Hysteresis Disabled.
01: Positive Hysteresis = 5 mV.
10: Positive Hysteresis = 10 mV.
11: Positive Hysteresis = 20 mV.

Bits1–0: **CP0HYN1–0**: Comparator0 Negative Hysteresis Control Bits.
00: Negative Hysteresis Disabled.
01: Negative Hysteresis = 5 mV.
10: Negative Hysteresis = 10 mV.
11: Negative Hysteresis = 20 mV.

9.2. Data Memory

The C8051F52x/F52xA/F53x/F53xAincludes 256 bytes of internal RAM mapped into the data memory space from 0x00 through 0xFF. The lower 128 bytes of data memory are used for general purpose registers and scratch pad memory. Either direct or indirect addressing may be used to access the lower 128 bytes of data memory. Locations 0x00 through 0x1F are addressable as four banks of general purpose registers, each bank consisting of eight byte-wide registers. The next 16 bytes, locations 0x20 through 0x2F, may either be addressed as bytes or as 128 bit locations accessible with the direct addressing mode.

The upper 128 bytes of data memory are accessible only by indirect addressing. This region occupies the same address space as the Special Function Registers (SFRs) but is physically separate from the SFR space. The addressing mode used by an instruction when accessing locations above 0x7F determines whether the CPU accesses the upper 128 bytes of data memory space or the SFRs. Instructions that use direct addressing will access the SFR space. Instructions using indirect addressing above 0x7F access the upper 128 bytes of data memory. Figure 9.1 illustrates the data memory organization of the C8051F52x/F52xA/F53x/F53xA.

9.3. General Purpose Registers

The lower 32 bytes of data memory (locations 0x00 through 0x1F) may be addressed as four banks of general-purpose registers. Each bank consists of eight byte-wide registers designated R0 through R7. Only one of these banks may be enabled at a time. Two bits in the program status word, RS0 (PSW.3) and RS1 (PSW.4), select the active register bank (see description of the PSW in SFR Definition 8.4. PSW: Program Status Word). This allows fast context switching when entering subroutines and interrupt service routines. Indirect addressing modes use registers R0 and R1 as index registers.

9.4. Bit Addressable Locations

In addition to direct access to data memory organized as bytes, the sixteen data memory locations at 0x20 through 0x2F are also accessible as 128 individually addressable bits. Each bit has a bit address from 0x00 to 0x7F. Bit 0 of the byte at 0x20 has bit address 0x00 while bit 7 of the byte at 0x20 has bit address 0x07. Bit 7 of the byte at 0x2F has bit address 0x7F. A bit access is distinguished from a full byte access by the type of instruction used (bit source or destination operands as opposed to a byte source or destination).

The MCS-51™ assembly language allows an alternate notation for bit addressing of the form XX.B where XX is the byte address and B is the bit position within the byte. For example, the instruction:

```
MOV    C, 22.3h
```

moves the Boolean value at 0x13 (bit 3 of the byte at location 0x22) into the Carry flag.

9.5. Stack

A programmer's stack can be located anywhere in the 256-byte data memory. The stack area is designated using the Stack Pointer (SP, 0x81) SFR. The SP will point to the last location used. The next value pushed on the stack is placed at SP+1 and then SP is incremented. A reset initializes the stack pointer to location 0x07. Therefore, the first value pushed on the stack is placed at location 0x08, which is also the first register (R0) of register bank 1. Thus, if more than one register bank is to be used, the SP should be initialized to a location in the data memory not being used for data storage. The stack depth can extend up to 256 bytes.

9.6. Special Function Registers

The direct-access data memory locations from 0x80 to 0xFF constitute the special function registers (SFRs). The SFRs provide control and data exchange with the CIP-51's resources and peripherals. The CIP-51 duplicates the SFRs found in a typical 8051 implementation as well as implementing additional

Table 9.2. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
REF0CN	0xD1	Voltage Reference Control	73
REG0CN	0xC9	Voltage Regulator Control	75
RSTSRC	0xEF	Reset Source Configuration/Status	112
SBUF0	0x99	UART0 Data Buffer	150
SCON0	0x98	UART0 Control	149
SP	0x81	Stack Pointer	87
SPI0CFG	0xA1	SPI Configuration	157
SPI0CKR	0xA2	SPI Clock Rate Control	159
SPI0CN	0xF8	SPI Control	158
SPI0DAT	0xA3	SPI Data	160
TCON	0x88	Timer/Counter Control	186
TH0	0x8C	Timer/Counter 0 High	189
TH1	0x8D	Timer/Counter 1 High	189
TL0	0x8A	Timer/Counter 0 Low	189
TL1	0x8B	Timer/Counter 1 Low	189
TMOD	0x89	Timer/Counter Mode	187
TMR2CN	0xC8	Timer/Counter 2 Control	193
TMR2H	0xCD	Timer/Counter 2 High	194
TMR2L	0xCC	Timer/Counter 2 Low	194
TMR2RLH	0xCB	Timer/Counter 2 Reload High	194
TMR2RLL	0xCA	Timer/Counter 2 Reload Low	194
VDDMON	0xFF	V_{DD} Monitor Control	109
XBR0	0xE1	Port I/O Crossbar Control 0	127
XBR1	0xE2	Port I/O Crossbar Control 1	128

SFR Definition 10.2. IP: Interrupt Priority

R	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	PSPI0	PT2	PS0	PT1	PX1	PT0	PX0	10000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Bit Addressable
							SFR Address:	0xB8

Bit7: **UNUSED**. Read = 1b; Write = don't care.
Bit6: **PSPI0**: Serial Peripheral Interface (SPI0) Interrupt Priority Control.
This bit sets the priority of the SPI0 interrupt.
0: SPI0 interrupt set to low priority level.
1: SPI0 interrupt set to high priority level.
Bit5: **PT2**: Timer 2 Interrupt Priority Control.
This bit sets the priority of the Timer 2 interrupt.
0: Timer 2 interrupt set to low priority level.
1: Timer 2 interrupt set to high priority level.
Bit4: **PS0**: UART0 Interrupt Priority Control.
This bit sets the priority of the UART0 interrupt.
0: UART0 interrupt set to low priority level.
1: UART0 interrupt set to high priority level.
Bit3: **PT1**: Timer 1 Interrupt Priority Control.
This bit sets the priority of the Timer 1 interrupt.
0: Timer 1 interrupt set to low priority level.
1: Timer 1 interrupt set to high priority level.
Bit2: **PX1**: External Interrupt 0 Priority Control.
This bit sets the priority of the external interrupt 1.
0: INT1 interrupt set to low priority level.
1: INT1 interrupt set to high priority level.
Bit1: **PT0**: Timer 0 Interrupt Priority Control.
This bit sets the priority of the Timer 0 interrupt.
0: Timer 0 interrupt set to low priority level.
1: Timer 0 interrupt set to high priority level.
Bit0: **PX0**: External Interrupt 0 Priority Control.
This bit sets the priority of the external interrupt 0.
0: INT0 interrupt set to low priority level.
1: INT0 interrupt set to high priority level.

SFR Definition 10.4. EIP1: Extended Interrupt Priority 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PMAT	PREG0	PLIN	PCPR	PCPF	PPAC0	PREG0	PWADC0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xF6

Bit7: **PMAT**. Port Match Interrupt Priority Control.
This bit sets the priority of the Port Match interrupt.
0: Port Match interrupt set to low priority level.
1: Port Match interrupt set to high priority level.

Bit6: **PREG0**: Voltage Regulator Interrupt Priority Control.
This bit sets the priority of the Voltage Regulator interrupt.
0: Voltage Regulator interrupt set to low priority level.
1: Voltage Regulator interrupt set to high priority level.

Bit5: **PLIN**: LIN Interrupt Priority Control.
This bit sets the priority of the CP0 interrupt.
0: LIN interrupt set to low priority level.
1: LIN interrupt set to high priority level.

Bit4: **PCPR**: Comparator Rising Edge Interrupt Priority Control.
This bit sets the priority of the Rising Edge Comparator interrupt.
0: Comparator interrupt set to low priority level.
1: Comparator interrupt set to high priority level.

Bit3: **PCPF**: Comparator falling Edge Interrupt Priority Control.
This bit sets the priority of the Falling Edge Comparator interrupt.
0: Comparator interrupt set to low priority level.
1: Comparator interrupt set to high priority level.

Bit2: **PPAC0**: Programmable Counter Array (PCA0) Interrupt Priority Control.
This bit sets the priority of the PCA0 interrupt.
0: PCA0 interrupt set to low priority level.
1: PCA0 interrupt set to high priority level.

Bit1: **PREG0**: ADC0 Conversion Complete Interrupt Priority Control.
This bit sets the priority of the ADC0 Conversion Complete interrupt.
0: ADC0 Conversion Complete interrupt set to low priority level.
1: ADC0 Conversion Complete interrupt set to high priority level.

Bit0: **PWADC0**: ADC0 Window Comparison Interrupt Priority Control.
This bit sets the priority of the ADC0 Window Comparison interrupt.
0: ADC0 Window Comparison interrupt set to low priority level.
1: ADC0 Window Comparison interrupt set to high priority level.

11.3. External Reset

The external RST pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the RST pin generates a reset; an external pullup and/or decoupling of the RST pin may be necessary to avoid erroneous noise-induced resets. See Table 2.8 on page 32 for complete RST pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

Note: Please refer to Section “20.6. Reset Low Time” on page 212 for restrictions on reset low time in older silicon revisions A and B.

11.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If the system clock remains high or low for more than 100 µs, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read 1, signifying the MCD as the reset source; otherwise, this bit reads 0. Writing a 1 to the MCDRSF bit enables the Missing Clock Detector; writing a 0 disables it. The state of the RST pin is unaffected by this reset.

11.5. Comparator Reset

Comparator0 can be configured as a reset source by writing a 1 to the C0RSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to C0RSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0-), the device is put into the reset state. After a Comparator0 reset, the C0RSEF flag (RSTSRC.5) will read 1 signifying Comparator0 as the reset source; otherwise, this bit reads 0. The state of the RST pin is unaffected by this reset.

11.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in Section “19.3. Watchdog Timer Mode” on page 203; the WDT is enabled and clocked by SYSCLK / 12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to 1. The state of the RST pin is unaffected by this reset.

11.7. Flash Error Reset

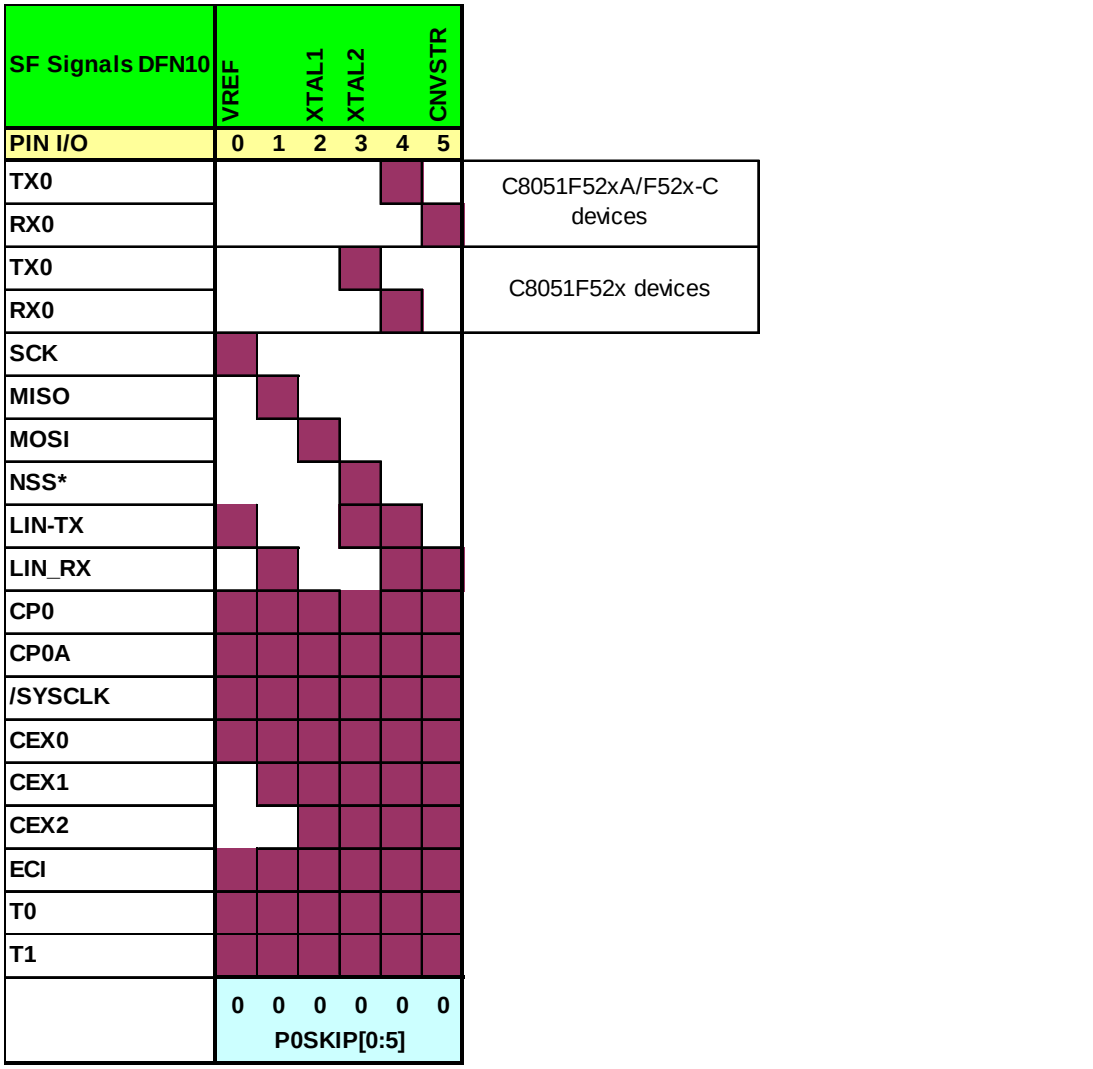
If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to 1 and a MOVX write operation targets an address above the Lock Byte address.
- A Flash read is attempted above user code space. This occurs when a MOVC operation targets an address above the Lock Byte address.
- A program read is attempted above user code space. This occurs when user code attempts to branch to an address above the Lock Byte address.
- A Flash read, write or erase attempt is restricted due to a Flash security setting (see Section “12.4. Security Options” on page 117).
- A Flash write or erase is attempted while the V_{DD} Monitor (VDDMON0) is disabled or not set to its high threshold setting.

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the RST pin is unaffected by this reset.

11.8. Software Reset

Software may force a reset by writing a 1 to the SWRSF bit (RSTSRC.4). The SWRSF bit will read 1 following a software forced reset. The state of the RST pin is unaffected by this reset.



Note: 4-Wire SPI Only.

Figure 13.5. Crossbar Priority Decoder with No Pins Skipped (DFN 10)

Important Note: The SPI can be operated in either 3-wire or 4-wire modes, depending on the state of the NSSMD1–NSSMD0 bits in register SPI0CN. According to the SPI mode, the NSS signal may or may not be routed to a Port pin.

13.2. Port I/O Initialization

Port I/O initialization consists of the following steps:

1. Select the input mode (analog or digital) for all Port pins, using the Port Input Mode register (PnMDIN).
2. Select the output mode (open-drain or push-pull) for all Port pins, using the Port Output Mode register (PnMDOUT).
3. Select any pins to be skipped by the I/O Crossbar using the Port Skip registers (PnSKIP).
4. Assign Port pins to desired peripherals using the XBRn registers.
5. Enable the Crossbar (XBARE = 1).

All Port pins must be configured as either analog or digital inputs. Any pins to be used as Comparator or ADC inputs should be configured as an analog inputs. When a pin is configured as an analog input, its weak pullup, digital driver, and digital receiver are disabled. This process saves power and reduces noise on the analog input. Pins configured as digital inputs may still be used by analog peripherals; however, this practice is not recommended.

Additionally, all analog input pins should be configured to be skipped by the Crossbar (accomplished by setting the associated bits in PnSKIP). Port input mode is set in the PnMDIN register, where a 1 indicates a digital input, and a 0 indicates an analog input. All pins default to digital inputs on reset. See SFR Definition 13.4 for the PnMDIN register details.

Important Note: Port 0 and Port 1 pins are 5.25 V tolerant across the operating range of V_{REGIN}.

The output driver characteristics of the I/O pins are defined using the Port Output Mode registers (PnMDOUT). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. When the WEAKPUD bit in XBR1 is 0, a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pullup is turned off on an output that is driving a 0 and for pins configured for analog input mode to avoid unnecessary power dissipation.

Registers XBR0 and XBR1 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR1 to 1 enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard Port I/O (in input mode), regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table.

The Crossbar must be enabled to use Port pins as standard Port I/O in output mode. **Port output drivers are disabled while the Crossbar is disabled.**

SFR Definition 13.11. P1MDOUT: Port1 Output Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xA5

Bits7–0: Output Configuration Bits for P1.7–P1.0 (respectively): ignored if corresponding bit in register P1MDIN is logic 0.
0: Corresponding P1.n Output is open-drain.
1: Corresponding P1.n Output is push-pull.

Note: When SDA and SCL appear on any of the Port I/O, each are open-drain regardless of the value of P0MDOUT.

SFR Definition 13.12. P1SKIP: Port1 Skip

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xD5

Bits7–0: **P1SKIP[7:0]**: Port1 Crossbar Skip Enable Bits.
These bits select Port pins to be skipped by the Crossbar Decoder. Port pins used as analog inputs (for ADC or Comparator) or used as special functions (V_{REF} input, external oscillator circuit, CNVSTR input) should be skipped by the Crossbar.
0: Corresponding P1.n pin is not skipped by the Crossbar.
1: Corresponding P1.n pin is skipped by the Crossbar.

15.3. Multiprocessor Communications

9-Bit UART mode supports multiprocessor communication between a master processor and one or more slave processors by special use of the ninth data bit. When a master processor wants to transmit to one or more slaves, it first sends an address byte to select the target(s). An address byte differs from a data byte in that its ninth bit is logic 1; in a data byte, the ninth bit is always set to logic 0.

Setting the MCE0 bit (SCON0.5) of a slave processor configures its UART such that when a stop bit is received, the UART will generate an interrupt only if the ninth bit is logic 1 (RB80 = 1) signifying an address byte has been received. In the UART interrupt handler, software will compare the received address with the slave's own assigned 8-bit address. If the addresses match, the slave will clear its MCE0 bit to enable interrupts on the reception of the following data byte(s). Slaves that weren't addressed leave their MCE0 bits set and do not generate interrupts on the reception of the following data bytes, thereby ignoring the data. Once the entire message is received, the addressed slave resets its MCE0 bit to ignore all transmissions until it receives the next address byte.

Multiple addresses can be assigned to a single slave and/or a single address can be assigned to multiple slaves, thereby enabling "broadcast" transmissions to more than one slave simultaneously. The master processor can be configured to receive all transmissions or a protocol can be implemented such that the master/slave role is temporarily reversed to enable half-duplex transmission between the original master and slave(s).

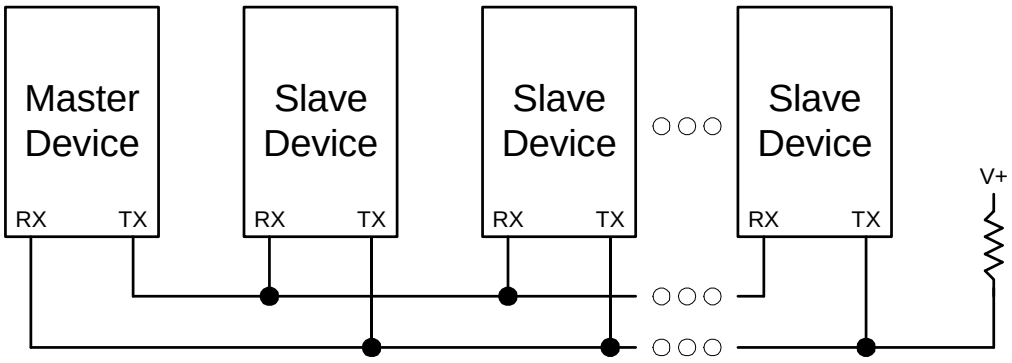


Figure 15.6. UART Multi-Processor Mode Interconnect Diagram

17.3. LIN Master Mode Operation

The master node is responsible for the scheduling of messages and sends the header of each frame, containing the SYNCH BREAK FIELD, SYNCH FIELD and IDENTIFIER FIELD. The steps to schedule a message transmission or reception are listed below.

1. Load the 6-bit Identifier into the LIN0ID register.
2. Load the data length into the LIN0SIZE register. Set the value to the number of data bytes or "1111b" if the data length should be decoded from the identifier. Also, set the checksum type, classic or enhanced, in the same LIN0SIZE register.
3. Set the data direction by setting the TXRX bit (LIN0CTRL.5). Set the bit to 1 to perform a master transmit operation, or set the bit to 0 to perform a master receive operation.
4. If performing a master transmit operation, load the data bytes to transmit into the data buffer (LIN0DT1 to LIN0DT8).
5. Set the STREQ bit (LIN0CTRL.0) to start the message transfer. The LIN peripheral will schedule the message frame and request an interrupt if the message transfer is successfully completed or if an error has occurred.

This code segment shows the procedure to schedule a message in a transmission operation:

```
LINADDR   = 0x08;// Point to LIN0CTRL
LINDATA  |=  0x20;// Select to transmit data
LINADDR   = 0x0E;// Point to LIN0ID
LINDATA   = 0x11;// Load the ID, in this example 0x11
LINADDR   = 0x0B;// Point to LIN0SIZE
LINDATA   = ( LINDATA & 0xF0 ) | 0x08; // Load the size with 8

LINADDR = 0x00;// Point to Data buffer first byte
for (i=0; i<8; i++)
{
   LINDATA = i + 0x41;// Load the buffer with ‘A’, ‘B’, ...
   LINADDR++;// Increment the address to the next buffer
}
LINADDR   = 0x08;// Point to LIN0CTRL
LINDATA   = 0x01;// Start Request
```

The application should perform the following steps when an interrupt is requested.

1. Check the DONE bit (LIN0ST.0) and the ERROR bit (LIN0ST.2).
2. If performing a master receive operation and the transfer was successful, read the received data from the data buffer.
3. If the transfer was not successful, check the error register to determine the kind of error. Further error handling has to be done by the application.
4. Set the RSTINT (LIN0CTRL.3) and RSTERR bits (LIN0CTRL.2) to reset the interrupt request and the error flags.

17.7.2. LIN Indirect Access SFR Registers Definition

Table 17.4. LIN Registers* (Indirectly Addressable)

Name	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
LIN0DT1	0x00	DATA1[7:0]							
LIN0DT2	0x01	DATA2[7:0]							
LIN0DT3	0x02	DATA3[7:0]							
LIN0DT4	0x03	DATA4[7:0]							
LIN0DT5	0x04	DATA5[7:0]							
LIN0DT6	0x05	DATA6[7:0]							
LIN0DT7	0x06	DATA7[7:0]							
LIN0DT8	0x07	DATA8[7:0]							
LIN0CTRL	0x08	STOP(s)	SLEEP(s)	TXRX	DTACK(s)	RSTINT	RSTERR	WUPREQ	STREQ(m)
LIN0ST	0x09	ACTIVE	IDLTOUT	ABORT(s)	DTREQ(s)	LININT	ERROR	WAKEUP	DONE
LIN0ERR	0x0A				SYNCH(s)	PRTY(s)	TOUT	CHK	BITERR
LIN0SIZE	0x0B	ENHCHK				LINSIZE[3:0]			
LIN0DIV	0x0C	DIVLSB[7:0]							
LIN0MUL	0x0D	PRESCL[1:0]		LINMUL[4:0]					DIV9
LIN0ID	0x0E			ID[5:0]					

*These registers are used in both master and slave mode. The register bits marked with (m) are accessible only in Master mode while the register bits marked with (s) are accessible only in slave mode. All other registers are accessible in both modes.

SFR Definition 17.4. LIN0DT1: LIN0 Data Byte 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

Address: 0x00 (indirect)

Bit7–0: **LIN0DT1**: LIN Data Byte 1.
Serial Data Byte 1 that is received or transmitted across the LIN interface.

SFR Definition 17.17. LIN0MUL: LIN0 Multiplier Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PRESCL[1:0]		LINMUL[4:0]					DIV9	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

Address: 0x0D (indirect)

Bit7–6: **PRESCL1–0**: LIN Baud Rate Prescaler Bits.
These bits are the baud rate prescaler bits.

Bit5–1: **LINMUL4–0**: LIN Baud Rate Multiplier Bits.
These bits are the baud rate multiplier bits. These bits are not used in slave mode.

Bit0: **DIV9**: LIN Baud Rate Divider Most Significant Bit.
The most significant bit of the baud rate divider. The 8 least significant bits are in LIN0DIV.
The valid range for the divider is 200 to 511.

SFR Definition 17.18. LIN0ID: LIN0 ID Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
		ID[5:0]						00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

Address: 0x0E (indirect)

Bit7–6: **UNUSED**. Read = 00b. Write = don't care.

Bit5–0: **ID5–0**: LIN Identifier Bits.
These bits form the data identifier.

If the LINSIZE bits (LIN0SIZE[3:0]) are 1111b, bits ID[5:4] are used to determine the data size and are interpreted as follows:
00: 2 bytes
01: 2 bytes
10: 4 bytes
11: 8 bytes

18.1.4. Mode 3: Two 8-bit Counter/Timers (Timer 0 Only)

In Mode 3, Timer 0 is configured as two separate 8-bit counter/timers held in TL0 and TH0. The counter/timer in TL0 is controlled using the Timer 0 control/status bits in TCON and TMOD: TR0, C/T0, GATE0 and TF0. TL0 can use either the system clock or an external input signal as its timebase. The TH0 register is restricted to a timer function sourced by the system clock or prescaled clock. TH0 is enabled using the Timer 1 run control bit TR1. TH0 sets the Timer 1 overflow flag TF1 on overflow and thus controls the Timer 1 interrupt.

Timer 1 is inactive in Mode 3. When Timer 0 is operating in Mode 3, Timer 1 can be operated in Modes 0, 1 or 2, but cannot be clocked by external signals nor set the TF1 flag and generate an interrupt. However, the Timer 1 overflow can be used to generate baud rates for the SMBus and UART. While Timer 0 is operating in Mode 3, Timer 1 run control is handled through its mode settings. To run Timer 1 while Timer 0 is in Mode 3, set the Timer 1 Mode as 0, 1, or 2. To disable Timer 1, configure it for Mode 3.

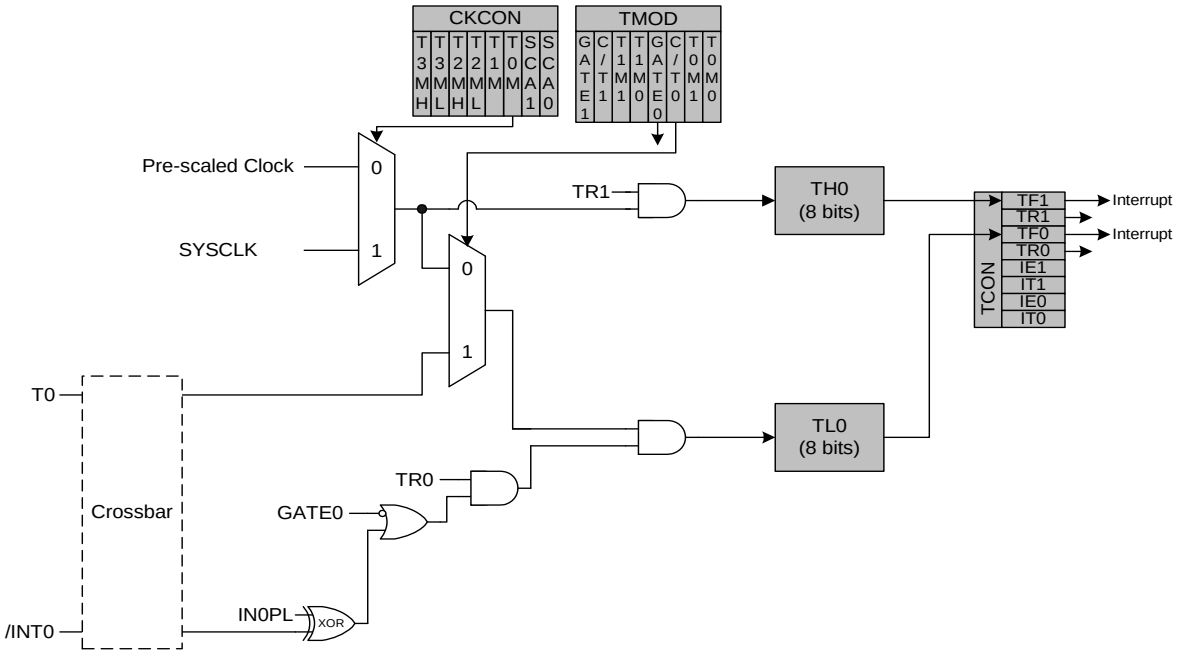
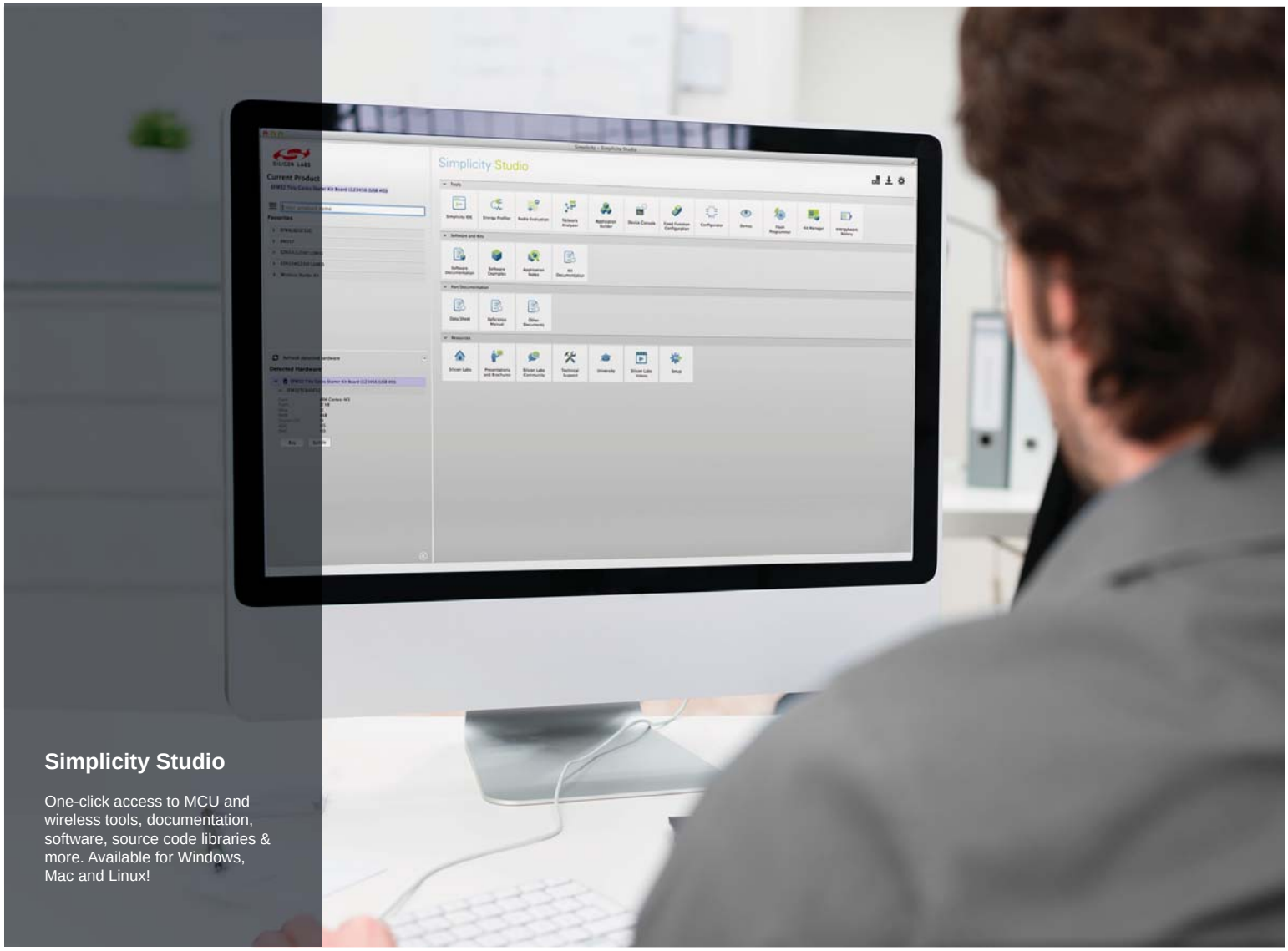


Figure 18.3. T0 Mode 3 Block Diagram



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